

WELCOME



Silicon Labs LIVE:

Wireless Connectivity Tech Talks

Talk Talks LIVE Schedule

Topic	Date
Bluetooth AoX Solutions	Thursday, April 2
15.4 Mesh Networking Technologies	Tuesday, April 7
Bluetooth Mesh Solutions & Tools	Thursday, April 9
Device & Network Security for the IoT	Tuesday, April 14
Evolution of Bluetooth 5, 5.1, & 5.2	Thursday, April 16
Connected Home Over IP (CHIP) for Beginners	Tuesday, April 21

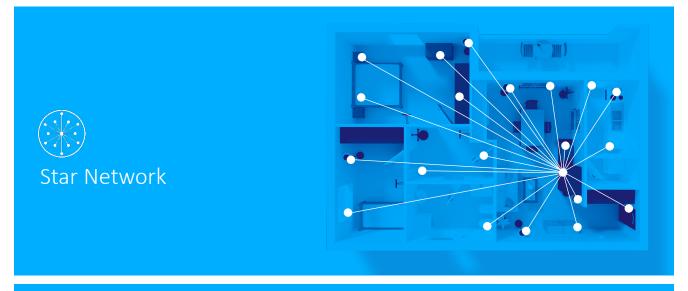
https://www.silabs.com/about-us/events/tech-talks



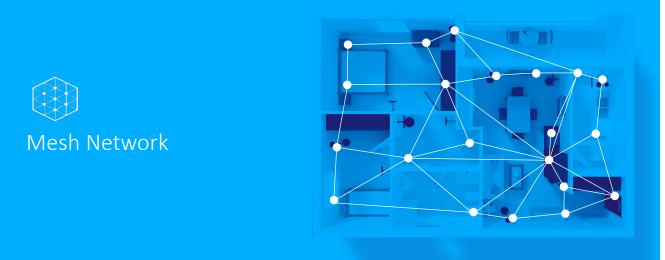
Silicon Labs *Bluetooth*® Mesh Solutions

APRIL 2020

Why Mesh Networking?



- Extends the range of connections from gateways or mobile devices with multi-hop communication
- Increases system scale by supporting large amount of devices in a single network
- Improves system reliability with multipath messaging network is not dependent on single nodes or routes
- Delivers optimal responsiveness with device to device communication



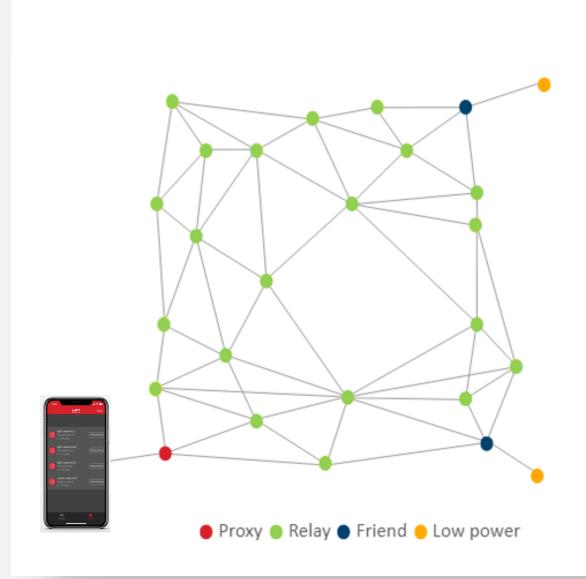
*) Silicon Labs has tested up to 240 devices

Why Bluetooth Mesh?



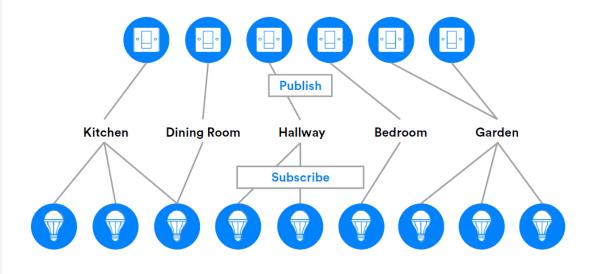
- Scale: Bluetooth mesh scales from small ten node networks to commercial grade networks with hundreds of nodes
- Phone connectivity: Phones can be used for easy network setup and configuration and mesh network can be used to deliver location services
- Gateway is optional in Bluetooth mesh networks, but can be used when it makes sense
- Industrial grade security: Bluetooth mesh implements state-of-the-art two-layer security with protection against all known security attacks
- Full stack interoperability: A Bluetooth SIG defined and driven standard from RF to application layer

Bluetooth Mesh Messaging



- Unicast, multicast and broadcast: Bluetooth mesh supports unicast, broadcast and multicast to address everything from a single node, to a group or a whole network
- Multipath: Bluetooth mesh uses a managed flood message relay that can inherently provide multipath delivery
- Managed flooding:
 - Time To Live (TTL): TTL is used in all Bluetooth mesh messages to control the number of hops over which a message will be relayed
 - Message cache: A message cache is implemented by all nodes and it is used to prevent recently seen messages from being transmitted again
 - Relaying is optional: All nodes do not need to implement relay feature

Bluetooth Mesh Publish - Subscribe



- The act of sending a message is known as **Publishing**
- Nodes are configured to select messages sent to specific addresses for processing, and this is known as Subscribing
- Typically, messages are addressed to group or virtual addresses
- The configuring application (i.e. mobile app or gateway) can assign meaningful names to the group/virtual addresses, making them easy and intuitive to use
- Only the device that is installed or replaced needs to be configured

Bluetooth Mesh: Models

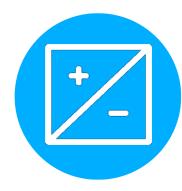
- Standard functionality defined by the Bluetooth SIG
- Client / Server
 - Server has data
 - Client reads or writes data
- Lighting Models
 - Light Lightness Client/Server
 - Light OnOff Client/Server
 - Light LC Server

Sensor Client / Sensor Server

- Over 100 standardized properties (Current, Voltage, Light Level, Temperature, Device Run Time, Occupancy, etc.)
- https://www.bluetooth.com/specifications/mesh-specifications/mesh-properties/
- Each sensor server can send one or more properties on a defined interval or as the data changes

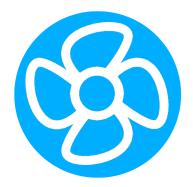


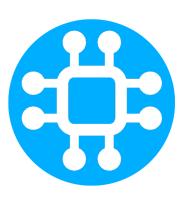




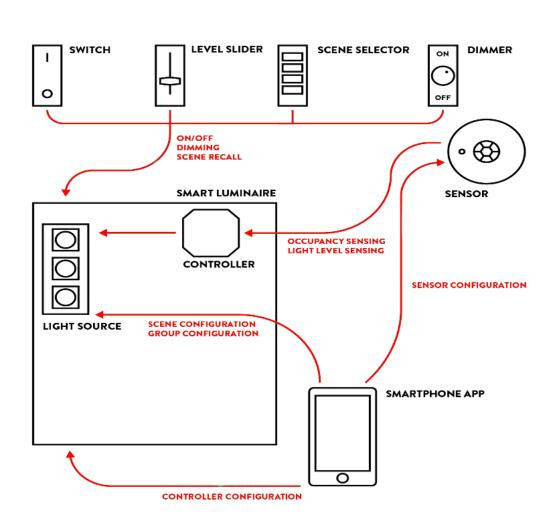
Vendor Model

- Used to implement custom functionality that's not defined by the SIG models
- Can stand alone and also be used on top of standard models to extend functionality
- Defined by custom opcodes that are used in the messaging
- For example:
 - opcode 0x1 = Command Set
 - opcode 0x2 = Status Get





Example: Bluetooth Mesh for Lighting



Lighting controls

- Multiple controls are supported from simple On/Off to composite devices with On/Off, dimming and scene capabilities
- Controls can be mains or battery powered

Sensors

- Typical use cases for sensors are occupancy and ambient light level sensing
- Again sensors can be mains or battery powered

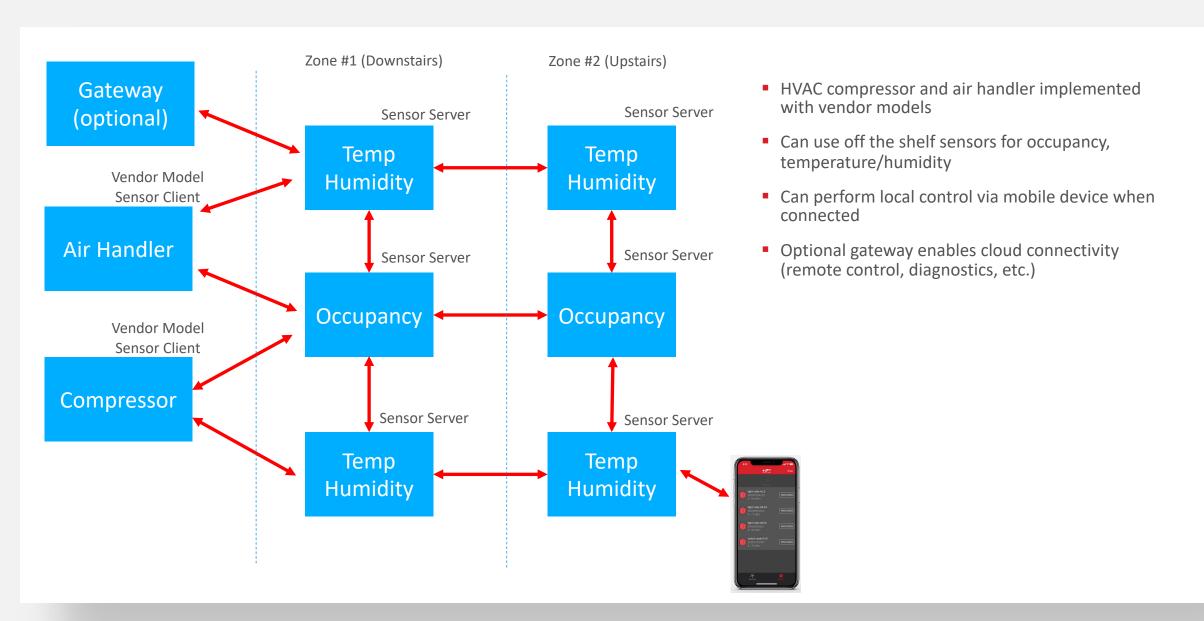
Led bulbs, drivers and luminaires

- Light sources are controlled by control or sensors
- For commercial lighting the Bluetooth mesh provides a Light Controller (LC) that controls lighting automatically based on inputs from controls and sensors
- These devices are typically mains powered and could for example also support Bluetooth beaconing

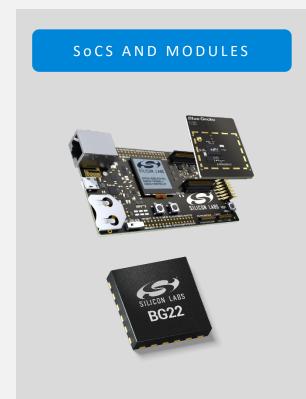
Smart phone apps or gateways

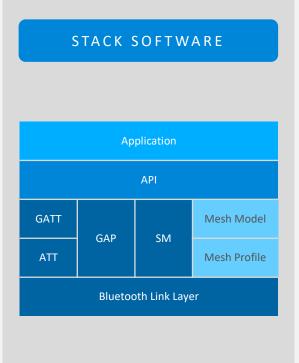
- Smart phone apps can be implemented for easy and fast network setup and configuration and management of devices
- Gateway is optional as intelligence is distributed to devices but it can be used where is makes sense

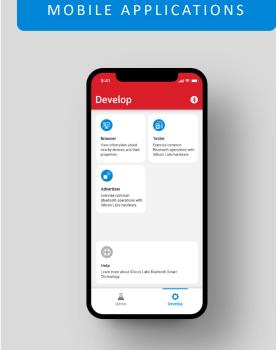
Example: Bluetooth Mesh for HVAC

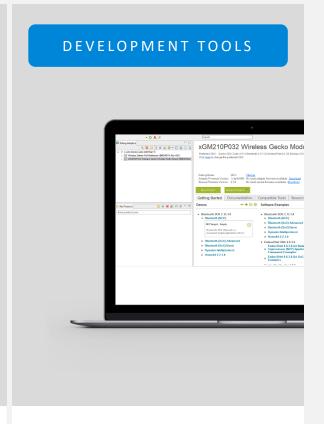


Silicon Labs: A Complete Solution for Enabling Bluetooth Products









Industry leading Bluetooth 5.1 and 5.2 SoCs and pre-certified modules

In-house developed stacks with latest Bluetooth 5.2 and the *industry's most complete mesh model implementation*

ADK, reference applications, and source code for iOS and Android

Free-of-charge software development and protocol analysis tools to boost productivity

Bluetooth Mesh - Mesh 1.0 Profile Features



EFR32BG21/13/12

Support all Bluetooth mesh features (Relay, Proxy, Friend etc.)
768-1024kB flash recommended for OTA

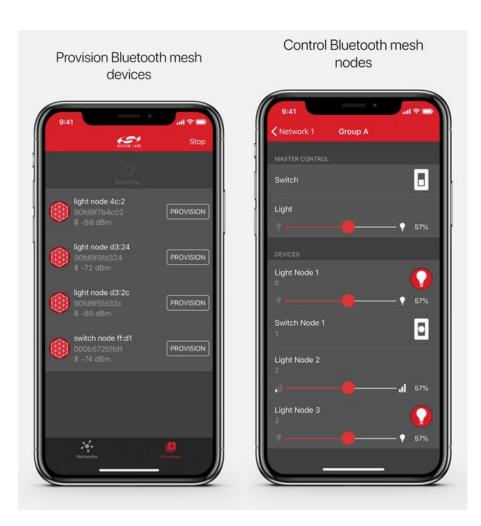


EFR32BG22

512kB parts support Bluetooth mesh LPN No support for Relay, Proxy or Friend

Feature	Value(s)
Supported features	Relay Proxy Friend Low Power Simultaneous BLE + BLE Mesh (GATT, custom beacons, etc.)
Provisioning bearers	PB-ADV PB-GATT
GATT services	Proxy Provisioning
Security	OoB authentication Replay protection Key refresh (blacklist) ECDH AES-128 encryption, authentication and obfuscation

Bluetooth Mesh Application Development Kit (ADKs)



- ADKs enable Bluetooth mesh application development for phones
 - Both iOS and Android platform are supported
 - ADKs provide a Bluetooth mesh stack for both platforms
 - ADK contains example code how to provision, configure and control mesh devices
 - LE connectivity uses the underlying Bluetooth API provided by the OS

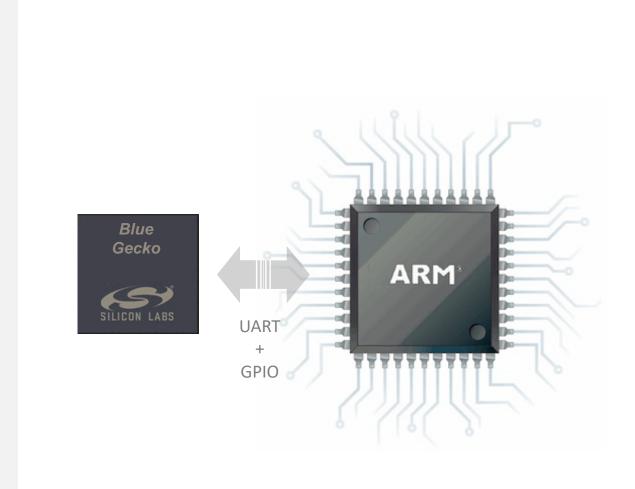
Features

- Node provisioning over LE connection and PB-GATT
- Mesh node settings configuration
- Mesh model configuration
- Node control
- Mesh database import/export
- Download for evaluation from <u>iTunes</u> or <u>Google</u>

Supported Bluetooth Mesh Models

Model Group	Model	Stack/APIs	Example app(s)	iOS APIs	iOS reference app	Android APIs	Android reference app
Vendor	Any vendor model	√		✓		√	
	OnOff	\checkmark	Light & Switch	\checkmark	\checkmark	✓	✓
	Level	\checkmark	Light & Switch	\checkmark	\checkmark	\checkmark	✓
	Default Transition Time	\checkmark	Light & Switch	\checkmark		\checkmark	
	Power OnOff	\checkmark	Light & Switch	\checkmark		\checkmark	
	Power Level	\checkmark		\checkmark			
Generic	Battery	\checkmark		\checkmark		\checkmark	
Generic	Location	\checkmark		\checkmark			
	Admin property	\checkmark		\checkmark			
	Manufacturer property	\checkmark		\checkmark			
	User property	\checkmark		\checkmark			
	Client property	\checkmark		\checkmark			
	Property	\checkmark		\checkmark			
	Lightness	\checkmark	Light & Switch	\checkmark	\checkmark	✓	✓
	CTL	\checkmark	Light & Switch	\checkmark	\checkmark	✓	✓
Lighting	LC	\checkmark	Light	\checkmark	\checkmark	✓	✓
	HSL						
	xYL						
Sensors	Sensor	\checkmark	\checkmark	\checkmark		\checkmark	
	Scene	\checkmark	Light and Switch	\checkmark		✓	
	Time	Q2′20		Q2'20		Q2′20	
4/	Scheduler	Q2'20		Q2'20		Q2′20	

Gateway Building Blocks: Network Co-Processor (NCP)



Network Co-Processor (NCP) architecture

- Bluetooth stack runs on the Blue Gecko SoC
- Provides Bluetooth API over UART I/F
- Application runs on a separate MCU

Host API

- Host API is 100% identical to SoC API
- Provided in source code and implements
 BGAPI serial protocol parser and API
- Various host example applications provided in the SDK

NCP features

- AES-128 encrypted UART communications
- 4-wire UART with RTS/CTS
- 1x GPIO for EM2 low-power management (optional)
- 1x GPIO to wake up host on Bluetooth events (optional)
- 1-3x 802.11 co-existence interface via GPIO pins
- NCP can be extended with custom APIs

Firmware update

Secure firmware update over UART

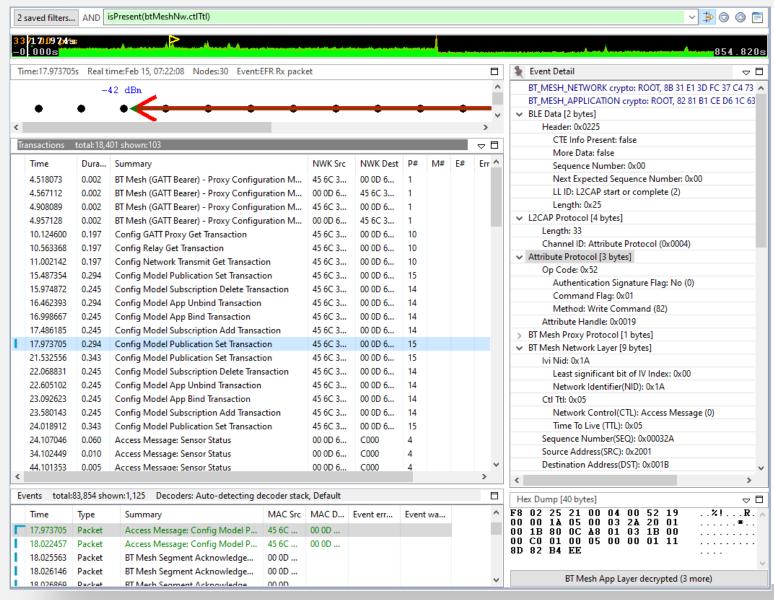
Best Development Tools for Bluetooth Mesh

- Network analyzer: Captures and decodes all Bluetooth traffic from every node in the network from a single PC
- Energy Profiler: Run time analysis of nodes energy consumption to optimize battery life
- WSTK: Development kits that can be Ethernet connected to build and test large mesh networks



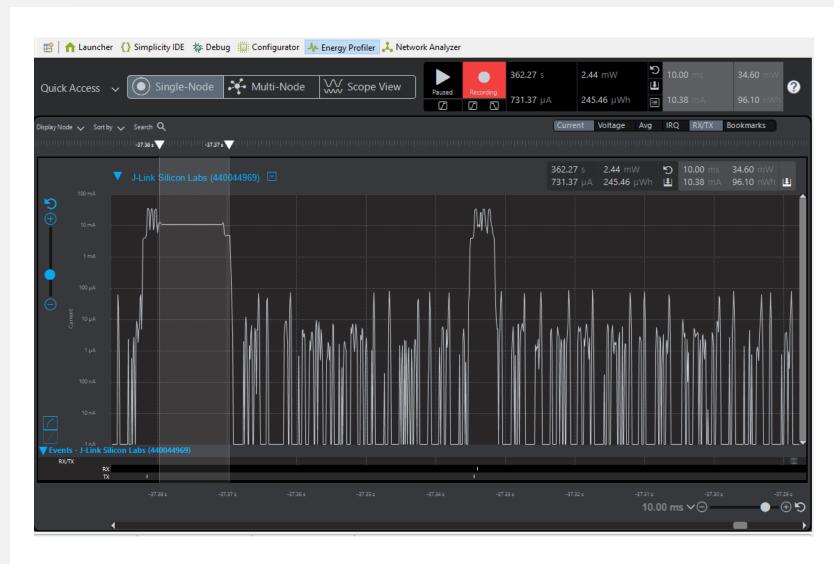


Network Analyzer



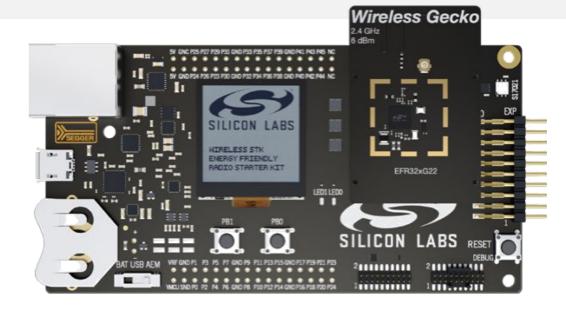
- Network Analyzer captures and decodes Bluetooth LE and mesh packets
 - Understand the network traffic easily
 - Debug connectivity or protocol issues
- Packets are received from a dedicated interface on EFR32
 - Accurately captures what a device transmits or receives
 - A Bluetooth sniffer only captures what it hears
- Capture directly from WSTK's USB or Ethernet
 - Live capture from multiple Ethernet networked WSTKs from a single PC
 - Allows much more coverage than a sniffer

Advanced Energy Monitor (AEM)

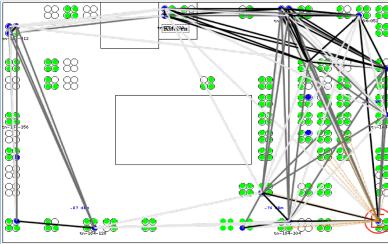


- Capable of measuring currents in the range of 0.1uA to 50mA
 - 0.1mA resolution at current > 250uA
 - 1uA resolution at current < 250uA
 - Can detect changes as small as 100nA when < 250uA
- Sample rate 10 ksps
- Correlation capabilities
 - Packet trace
 - Code instructions
 - Interrupts
 - Radio Activity (RX/TX)

Wireless Starter Kit (WSTK)







- Interfaces: Ethernet/TCP and USB
- Functionality (Available over USB or TCP)
 - Packet Trace
 - Firmware flashing and debugging
 - Serial console interface
 - Advanced Energy Monitor
- Works with installed Silabs radio modules as well as external targets connected to WSTK via debug cable
- WSTKs can be used to build large test networks
 - Silicon Labs has WSTK networks sized at 200+ nodes

BG21: Optimized for Secure Mains Powered Devices









Radio

Up to +20 dBm TX Extremely good RX sensitivity Bluetooth 5.1 802.15.4

Current Consumption

8.8 mA RX (1 Mbit/s GFSK) 10.5 mA TX @ 0 dBm 33.8 mA TX @ 10 dBm 4-8uA EM2

World Class Protocol Stacks

Bluetooth 5.1 and Bluetooth mesh Zigbee 3.0 OpenThread Apple HomeKit

Compact Size

4x4 QFN32 (20 GPIO)

ARM Cortex-M33 with TrustZone

80 MHz w/ FPU and DSP Up to 92kB RAM and 1024kB flash 50.9 μA/MHz

Peripherals Fit for Purpose

3x USART, 2x I2C 1x 12-bit ADC, 2x ACMP 7x timers Up to 20x GPIO

Security

True Random Number Generator Hardware Accelerated Crypto Engine Secure Boot with root of trust Secure debug with lock/unlock **DPA Countermeasures**

With Secure Vault™

Anti tamper Secure attestation Secure key management and storage Advanced crypto

BG21 can be paired with EFP to reduce active TX/RX current consumption

BG22: Optimized for Battery Powered Bluetooth LE and Mesh

Optimized



BG22 (512kB flash variant) only support Bluetooth mesh Low Power Node feature and software support is available in Q2'20 SDK

BG13 or BG21+EFP can also be used for low power applications

Secure Bluetooth 5.2 SoCs for High-Volume Products

Radio

Bluetooth 5.2 +6 dBm TX -99 dBm RX AoA & AoD

Ultra-Low Power

3.6mA Radio TX
2.6mA Radio RX
1.4uA EM2 with 32kB RAM
0.54uA in EM4
RTC in EM4

World Class Software

Bluetooth 5.2 Bluetooth mesh LPN Direction Finding

Compact Size

5x5 QFN40 (26 GPIO) 4x4 QFN32 (18 GPIO) 4x4 TQFN32 (18 GPIO)

ARM Cortex-M33 with TrustZone

76.8 MHz FPU and DSP 352/512kB of flash 32kB RAM

Peripherals Fit for Purpose

2x USART, 2x I2C, 2x PDM and GPIO 12-bit ADC (16 channels) Built-in temperature sensor with +/- 1.5 °C 32kHz, 500ppm PLFRCO

Security

True Random Number Generator Hardware Accelerated Crypto Engine Secure Boot with root of trust Secure debug with lock/unlock

Silicon Labs' Bluetooth SoC Families

	Series 1 - xG13	Series 2 - xG21	Series 2 - xG22
Target applications	General purpose Bluetooth LE and mesh	Mains powered Bluetooth LE and mesh	Lowest power Bluetooth LE, Direction Finding and Bluetooth mesh LPNs
Bluetooth features	5.1 and mesh 1.0 (1M, 2M, LE Coded PHYs and AE)	5.1 and mesh 1.0 (1M, 2M, LE Coded PHYs and AE)	5.2 and Bluetooth mesh LPN (1M, 2M, LE Coded PHYs, AE and AoA/D)
Proprietary 2.4G	2/4(G)FSK, OQPSK/(G)MSK, DSSS, BPSK/DBPSK TX, OOK/ASK	N/A	2/4(G)FSK, (G)MSK, OQPSK, DSSS
TX / RX (1M, GFSK)	+19 dBm / -95.8 dBm	+20 dBm / -97.5 dBm	+6 dBm / -99 dBm
TX Current (0 dBm)	10.5 mA	10.5 mA	4.1 mA 7.4 mA (6 dBm)
RX Current (1M, GFSK)	9.5 mA	8.8mA	3.6 mA
CPU / Clock Speed	Cortex M4 (38.4 MHz)	Cortex M33 (80Mhz)	Cortex M33 (up to 76.8MHz) Cortex M0+ for radio
Flash (kB)	512	Up to 1024	Up to 512
RAM (kB)	64	Up to 96	32
Sleep Current (EM2)	1.3μA (16kB RAM)	4.5 uA (96 RAM)	1.24 uA (8kB RAM) - 1.44 uA (32kB RAM)
Active Current (EM0)	70μA/MHz	51uA/MHz	25uA/MHz
Security	2x AES-128/256, ECC, SHA-1/224/256, TRNG	AES-128/256, SHA-1/2 ECC, ECDSA and TRNG DPA countermeasures Secure boot with RTSL Secure debug with debug lock/unlock	AES-128/256, SHA-1/2 ECC, ECDSA and TRNG Secure boot with RTSL Secure debug with debug lock/unlock
Operating Voltage	1.8V – 3.6V	1.8V – 3.8V	1.71V – 3.8V
Packages (mm)	7x7 QFN48, 5x5 QFN32	4x4 QFN32 (20x GPIO)	5x5 QFN40 (26x GPIO) 4x4 QFN32, TQFN32 (18x GPIO)

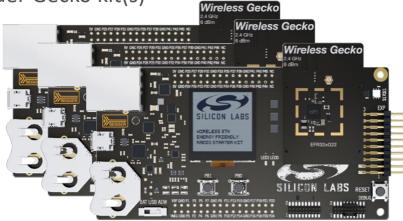
Silicon Labs' Bluetooth Module Families

	SILEDI LAES BIU Gaeko BGM3P BGM13P	STILICEN LARS BGM13S BGM13S	SILICON LABS DISPRISE BGM210P	BGM210L	SILICON LABS BGM220P BGM220P (Q3'20)	SILICUN LABS BGM220S BGM220S (Q3'20)
Protocols	5.1 and mesh (1M, 2M, Coded PHY and AE)	5.1 and mesh (1M, 2M, Coded PHY and AE)	5.1 and mesh 1.0 (1M, 2M, Coded PHY and AE)	5.1 and mesh 1.0 (1M, 2M, Coded PHY and AE)	5.2 and mesh 1.0 LPN (1M, 2M, Coded PHY, AE and AoA/D)	5.2 and mesh 1.0 LPN (1M, 2M, Coded PHY, AE and AoA/D)
EFR32 SoC	BG13	BG13	BG21	BG21	BG22	BG22
Antenna	Built-in or U.FL	Built-in or RF pin	Built-in or RF pin	Built-in	Built-in	Built-in or RF pin
Max TX power	+8 / +19 dBm	+8 / +18 dBm	+10 / +20 dBm	+12.5 dBm	+8 dBm	+6 dBm
Sensitivity (1M)	-94.8 dBm	-94.1 dBm	-97 dBm	-97 dBm	-98 dBm	-98 dbm
Flash (kB)	512	512	1024	1024	512	512
RAM (kB)	64	64	96	96	32	32
GPIO	25	30	20	12	24,25	25
Operating Voltage	1.8V – 3.6V	1.8V – 3.6V	1.8 – 3.8V	1.8 – 3.8V	1.71V – 3.8V	1.71V – 3.8V
Operating Temp.	-40 to +85C	-40 to +85C	-40 to +125C	-40 to +125C	-40 to +105C	-40 to +105C
Dimensions W x L x H (mm)	13.0 x 15.0 x 2.2	6.5 x 6.5 x 1.4	13.0 x 15.0 x 2.2	13.0 x 15.0 x 2.2	13.0 x 15.0 x 2.2	6 x 6 x 1.3
Certifications	BT, CE, FCC, ISED, Japan, S-Korea and Taiwan	BT, CE, FCC, ISED, Japan & S-Korea	BT, CE, FCC, ISED, Japan & S-Korea	BT, CE, FCC, ISED, Japan & S-Korea	BT, CE, FCC, ISED, Japan & S-Korea	BT, CE, FCC, ISED, Japan & S-Korea

Getting Started

https://www.silabs.com/support/getting-started/bluetooth/bluetooth-mesh

1. Order Gecko kit(s)



SLWSTK6006A

3. Download the Bluetooth Mesh mobile app for iOS or Android

2. Install Simplicity Studio



4. Explore our online resources

LEARNING CENTER Bluetooth Mesh Technology Resources Learn More >

Bluetooth Mesh Stack

Review the Bluetooth mesh stack

► View Video

Messaging and Node Types

Learn how different Bluetooth mesh nodes communicate with

View Video

Bluetooth Mesh in Action

See the Bluetooth mesh technology and mobile application in action.

(Watch Now

BG22 Virtual Workshop



Learn how to develop and deploy more powerful, efficient, and secure IoT products with your own BG22 Thunderboard – free for all registrants!

North America: May 19th–21st, 2020

10:00AM -11:30 AM CST

(Other sessions available for Asia Pacific and Europe)

Register today! https://www.silabs.com/about-us/events/virtual-bluetooth-workshop



Thank You!

Q & A

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